



BUK7S1R0-40H

N-channel 40 V, 1.0 mΩ standard level MOSFET in LPAK88

26 April 2019

Product data sheet

1. General description

Automotive qualified N-channel MOSFET using the latest Trench 9 low ohmic superjunction technology, housed in a copper-clip LPAK88 package. This product has been fully designed and qualified to meet beyond AEC-Q101 requirements delivering high performance and reliability.

2. Features and benefits

- Fully automotive qualified to beyond AEC-Q101:
 - 55 °C to +175 °C rating suitable for thermally demanding environments
- LPAK88 package:
 - Designed for smaller footprint and improved power density over older wire bond packages such as D²PAK for today's space constrained high power automotive applications
 - Thin package and copper clip enables LPAK88 to be highly efficient thermally
- LPAK copper clip technology enabling improvements over wire bond packages by:
 - Increased maximum current capability and excellent current spreading
 - Improved R_{DSon}
 - Low source inductance
 - Low thermal resistance R_{th}
- LPAK Gull Wing leads:
 - Flexible leads enabling high Board Level Reliability absorbing mechanical and thermal cycling stress, unlike traditional QFN packages
 - Visual (AOI) soldering inspection, no need for expensive x-ray equipment
 - Easy solder wetting for good mechanical solder joint
- Unique 40 V Trench 9 superjunction technology:
 - Reduced cell pitch and superjunction platform enables lower R_{DSon} in the same footprint
 - Improved SOA and avalanche capability compared to standard TrenchMOS
 - Tight $V_{GS(th)}$ limits enable easy paralleling of MOSFETs

3. Applications

- 12 V automotive systems
- 48 V DC/DC systems (on 12 V secondary side)
- Higher power motors, lamps and solenoid control
- Reverse polarity protection
- LED lighting
- Ultra high performance power switching

4. Quick reference data

Table 1. Quick reference data

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|-----------|-------------------------|---|-----|-----|-----|-----|------|
| V_{DS} | drain-source voltage | $25\text{ °C} \leq T_j \leq 175\text{ °C}$ | | - | - | 40 | V |
| I_D | drain current | $V_{GS} = 10\text{ V}$; $T_{mb} = 25\text{ °C}$; Fig. 2 | [1] | - | - | 325 | A |
| P_{tot} | total power dissipation | $T_{mb} = 25\text{ °C}$; Fig. 1 | | - | - | 375 | W |

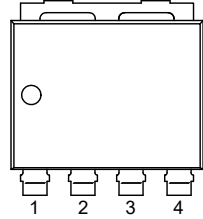
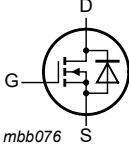
| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--------------------------------|----------------------------------|---|------|------|-----|------|
| Static characteristics | | | | | | |
| $R_{DS(on)}$ | drain-source on-state resistance | $V_{GS} = 10\text{ V}$; $I_D = 25\text{ A}$; $T_j = 25\text{ }^{\circ}\text{C}$; Fig. 11 | 0.62 | 0.88 | 1 | mΩ |
| Dynamic characteristics | | | | | | |
| Q_{GD} | gate-drain charge | $I_D = 25\text{ A}$; $V_{DS} = 32\text{ V}$; $V_{GS} = 10\text{ V}$; Fig. 13 ; Fig. 14 | - | 17 | 34 | nC |
| Source-drain diode | | | | | | |
| Q_r | recovered charge | $I_S = 25\text{ A}$; $di_S/dt = -100\text{ A}/\mu\text{s}$; $V_{GS} = 0\text{ V}$; $V_{DS} = 20\text{ V}$ [2] | - | 49 | - | nC |
| S | softness factor | $I_S = 25\text{ A}$; $di_S/dt = -100\text{ A}/\mu\text{s}$; $V_{GS} = 0\text{ V}$; $V_{DS} = 20\text{ V}$; $T_j = 25\text{ }^{\circ}\text{C}$ | - | 0.8 | - | |

[1] 325A continuous current has been successfully demonstrated during application. practically the current will be limited by PCB, thermal design and operating temperature.

[2] includes capacitive recovery

5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|-----------------------------------|---|--|
| 1 | G | gate |  <p>LFPAK88 (SOT1235)</p> |  <p>mbb076</p> |
| 2 | S | source | | |
| 3 | S | source | | |
| 4 | S | source | | |
| mb | D | mounting base; connected to drain | | |

6. Ordering information

Table 3. Ordering information

| Type number | Package | | |
|--------------|---------|---|---------|
| | Name | Description | Version |
| BUK7S1R0-40H | LFPAK88 | plastic, single-ended surface-mounted package (LFPAK88); 4 leads; 2 mm pitch; 8 mm x 8 mm x 1.6 mm body | SOT1235 |

7. Marking

Table 4. Marking codes

| Type number | Marking code |
|--------------|--------------|
| BUK7S1R0-40H | 7S1R040H |

8. Limiting values

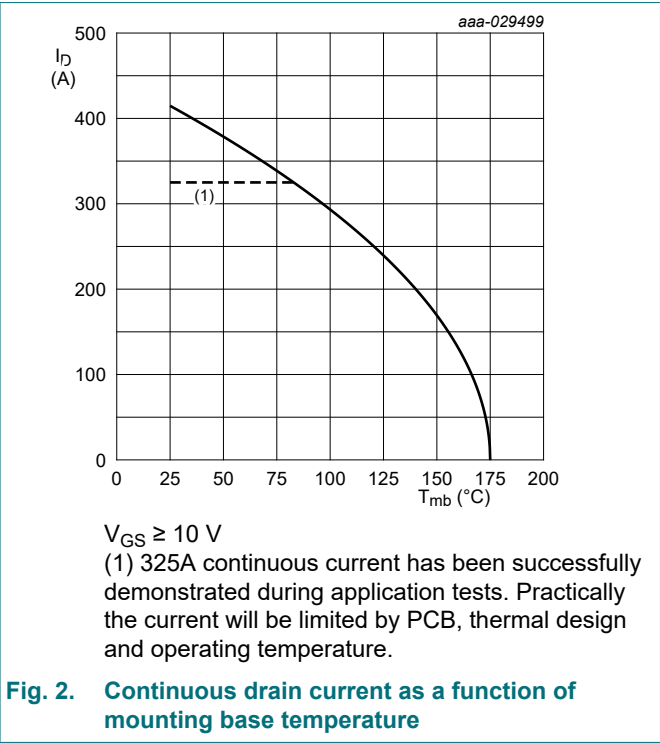
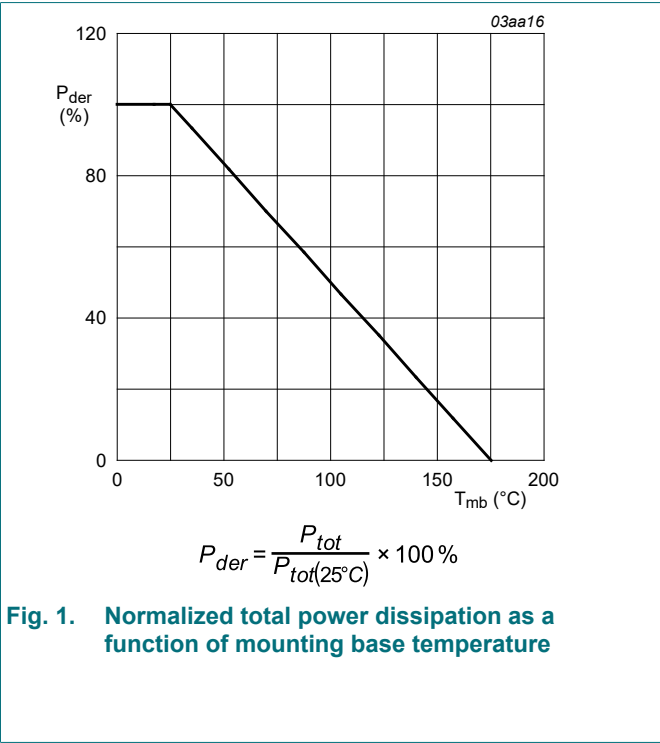
Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|----------|----------------------|--|-----|-----|------|
| V_{DS} | drain-source voltage | $25\text{ }^{\circ}\text{C} \leq T_j \leq 175\text{ }^{\circ}\text{C}$ | - | 40 | V |

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|----------------------|--|--|---------|-----|------|------|
| V _{GS} | gate-source voltage | DC; T _j ≤ 175 °C | | -10 | 20 | V |
| P _{tot} | total power dissipation | T _{mb} = 25 °C; Fig. 1 | | - | 375 | W |
| I _D | drain current | V _{GS} = 10 V; T _{mb} = 25 °C; Fig. 2 | [1] | - | 325 | A |
| I _{DM} | peak drain current | pulsed; t _p ≤ 10 μs; T _{mb} = 25 °C; Fig. 3 | | - | 1659 | A |
| T _{stg} | storage temperature | | | -55 | 175 | °C |
| T _j | junction temperature | | | -55 | 175 | °C |
| Source-drain diode | | | | | | |
| I _S | source current | T _{mb} = 25 °C | [2] | - | 350 | A |
| I _{SM} | peak source current | pulsed; t _p ≤ 10 μs; T _{mb} = 25 °C | | - | 1659 | A |
| Avalanche ruggedness | | | | | | |
| E _{DS(AL)S} | non-repetitive drain-source avalanche energy | I _D = 120 A; V _{sup} ≤ 40 V; R _{GS} = 50 Ω; V _{GS} = 10 V; T _{j(init)} = 25 °C; unclamped; Fig. 4 | [3] [4] | - | 437 | mJ |

- [1] 325A continuous current has been successfully demonstrated during application. practically the current will be limited by PCB, thermal design and operating temperature.
- [2] 350A continuous current has been successfully demonstrated during application. practically the current will be limited by PCB, thermal design and operating temperature.
- [3] single pulse avalanche rating limited by maximum junction temperature of 175°C
- [4] refer to application note AN10273 for further information



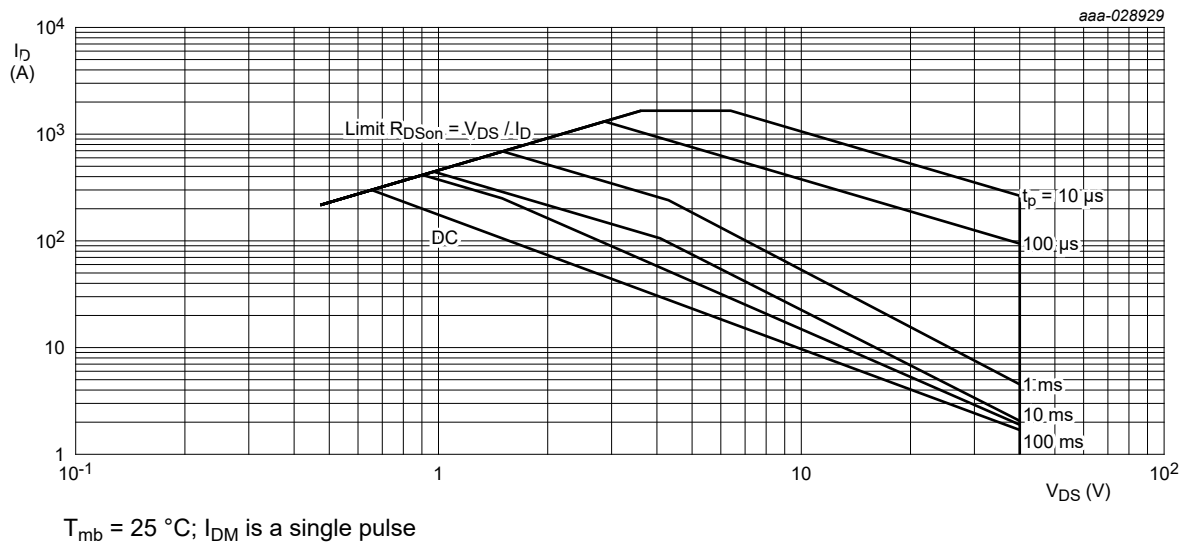
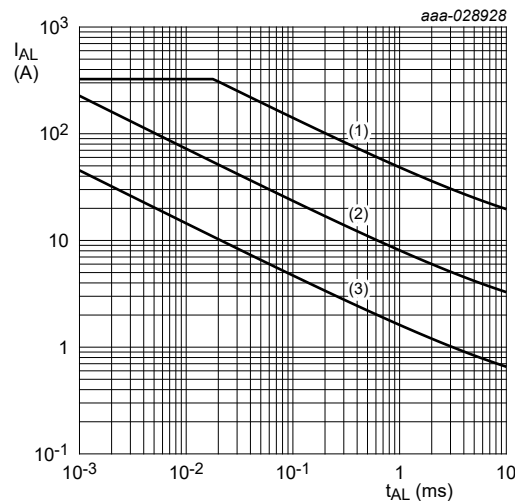


Fig. 3. Safe operating area; continuous and peak drain currents as a function of drain-source voltage



(1) $T_{j\ (init)} = 25\ ^\circ C$; (2) $T_{j\ (init)} = 150\ ^\circ C$; (3) Repetitive Avalanche

Fig. 4. Avalanche rating; avalanche current as a function of avalanche time

9. Thermal characteristics

Table 6. Thermal characteristics

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|----------------|---|------------|-----|------|-----|------|
| $R_{th(j-mb)}$ | thermal resistance from junction to mounting base | Fig. 5 | - | 0.35 | 0.4 | K/W |

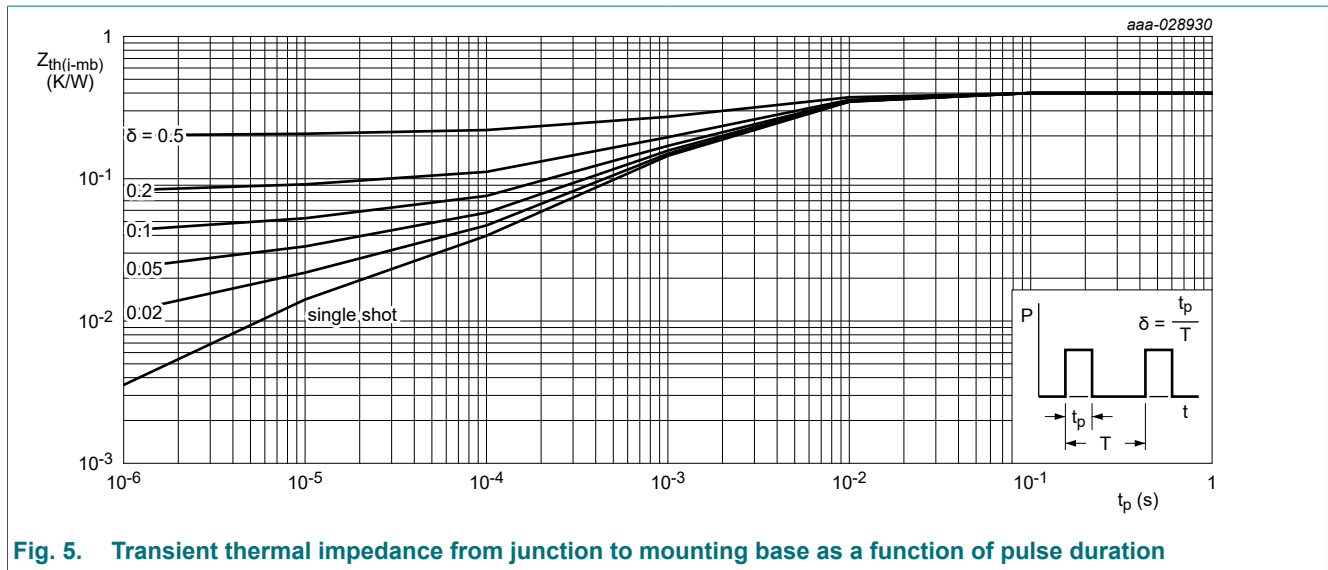


Fig. 5. Transient thermal impedance from junction to mounting base as a function of pulse duration

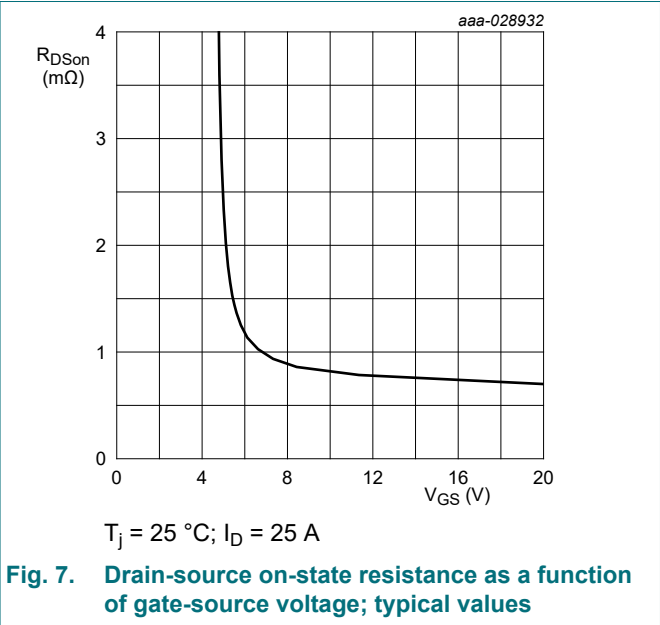
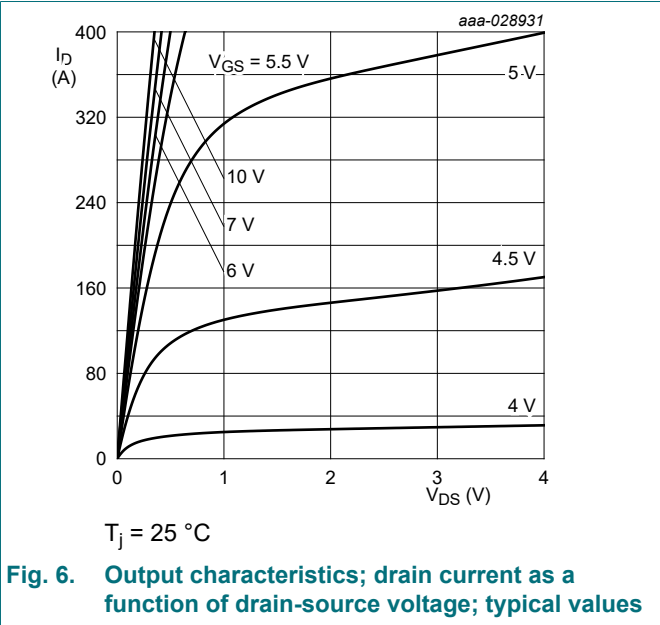
10. Characteristics

Table 7. Characteristics

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--------------------------------|----------------------------------|---|------|------|------|---------|
| Static characteristics | | | | | | |
| $V_{(BR)DSS}$ | drain-source breakdown voltage | $I_D = 250 \mu A$; $V_{GS} = 0 V$; $T_J = 25 ^\circ C$ | 40 | 43 | - | V |
| | | $I_D = 250 \mu A$; $V_{GS} = 0 V$; $T_J = -40 ^\circ C$ | - | 40.5 | - | V |
| | | $I_D = 250 \mu A$; $V_{GS} = 0 V$; $T_J = -55 ^\circ C$ | 36 | 40 | - | V |
| $V_{GS(th)}$ | gate-source threshold voltage | $I_D = 1 mA$; $V_{DS}=V_{GS}$; $T_J = 25 ^\circ C$; Fig. 9 ; Fig. 10 | 2.4 | 3 | 3.6 | V |
| | | $I_D = 1 mA$; $V_{DS}=V_{GS}$; $T_J = 175 ^\circ C$; Fig. 10 | 1 | - | - | V |
| | | $I_D = 1 mA$; $V_{DS}=V_{GS}$; $T_J = -55 ^\circ C$; Fig. 10 | - | - | 4.3 | V |
| I_{DSS} | drain leakage current | $V_{DS} = 40 V$; $V_{GS} = 0 V$; $T_J = 25 ^\circ C$ | - | 0.2 | 1.5 | μA |
| | | $V_{DS} = 16 V$; $V_{GS} = 0 V$; $T_J = 125 ^\circ C$ | - | 4.7 | 25 | μA |
| | | $V_{DS} = 40 V$; $V_{GS} = 0 V$; $T_J = 175 ^\circ C$ | - | 287 | 1000 | μA |
| I_{GSS} | gate leakage current | $V_{GS} = 20 V$; $V_{DS} = 0 V$; $T_J = 25 ^\circ C$ | - | 2 | 100 | nA |
| | | $V_{GS} = -10 V$; $V_{DS} = 0 V$; $T_J = 25 ^\circ C$ | - | 2 | 100 | nA |
| $R_{DS(on)}$ | drain-source on-state resistance | $V_{GS} = 10 V$; $I_D = 25 A$; $T_J = 25 ^\circ C$; Fig. 11 | 0.62 | 0.88 | 1 | mΩ |
| | | $V_{GS} = 10 V$; $I_D = 25 A$; $T_J = 105 ^\circ C$; Fig. 12 | 0.87 | 1.3 | 1.6 | mΩ |
| | | $V_{GS} = 10 V$; $I_D = 25 A$; $T_J = 125 ^\circ C$; Fig. 12 | 0.97 | 1.4 | 1.75 | mΩ |
| | | $V_{GS} = 10 V$; $I_D = 25 A$; $T_J = 175 ^\circ C$; Fig. 12 | 1.2 | 1.8 | 2.2 | mΩ |
| R_G | gate resistance | $f = 1 MHz$; $T_J = 25 ^\circ C$ | 0.4 | 0.9 | 2.3 | Ω |
| Dynamic characteristics | | | | | | |
| $Q_{G(tot)}$ | total gate charge | $I_D = 25 A$; $V_{DS} = 32 V$; $V_{GS} = 10 V$; Fig. 13 ; Fig. 14 | - | 98 | 137 | nC |
| Q_{GS} | gate-source charge | | - | 27 | 40 | nC |
| Q_{GD} | gate-drain charge | | - | 17 | 34 | nC |

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|---------------------|------------------------------|--|---------------------|-----|------|-------|------|
| C _{iss} | input capacitance | V _{DS} = 25 V; V _{GS} = 0 V; f = 1 MHz; T _j = 25 °C; Fig. 15 | | - | 7373 | 10322 | pF |
| C _{oss} | output capacitance | | | - | 1578 | 2209 | pF |
| C _{rss} | reverse transfer capacitance | | | - | 295 | 649 | pF |
| t _{d(on)} | turn-on delay time | V _{DS} = 30 V; R _L = 1.2 Ω; V _{GS} = 10 V; R _{G(ext)} = 5 Ω | | - | 23 | - | ns |
| t _r | rise time | | | - | 19 | - | ns |
| t _{d(off)} | turn-off delay time | | | - | 59 | - | ns |
| t _f | fall time | | | - | 26 | - | ns |
| Source-drain diode | | | | | | | |
| V _{SD} | source-drain voltage | V _{GS} = 0 V; T _j = 25 °C; Fig. 16 | | - | 0.76 | 1 | V |
| t _{rr} | reverse recovery time | I _S = 25 A; dI _S /dt = -100 A/μs; V _{GS} = 0 V; V _{DS} = 20 V | | - | 43 | - | ns |
| Q _r | recovered charge | | [1] | - | 49 | - | nC |
| S | softness factor | I _S = 25 A; dI _S /dt = -100 A/μs; V _{GS} = 0 V; V _{DS} = 20 V; T _j = 25 °C | | - | 0.8 | - | |
| | | I _S = 25 A; dI _S /dt = -500 A/μs; V _{GS} = 0 V; V _{DS} = 20 V; T _j = 25 °C | | - | 0.7 | - | |

[1] includes capacitive recovery



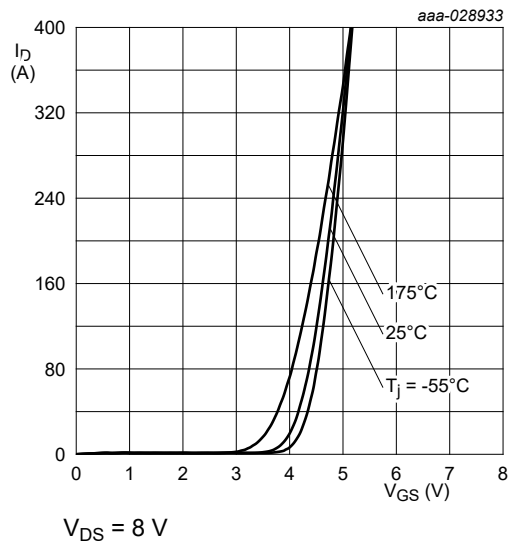


Fig. 8. Transfer characteristics; drain current as a function of gate-source voltage; typical values

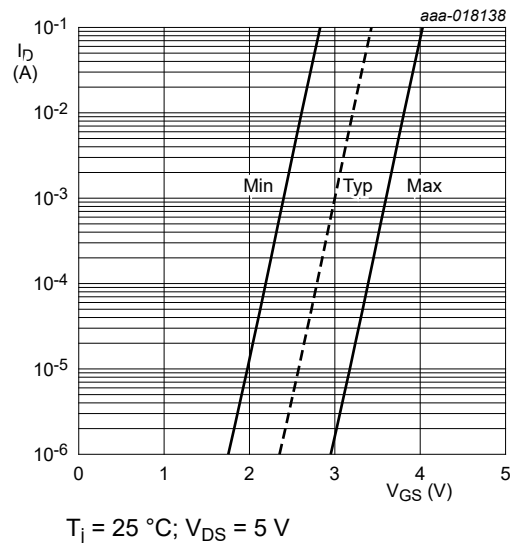


Fig. 9. Sub-threshold drain current as a function of gate-source voltage

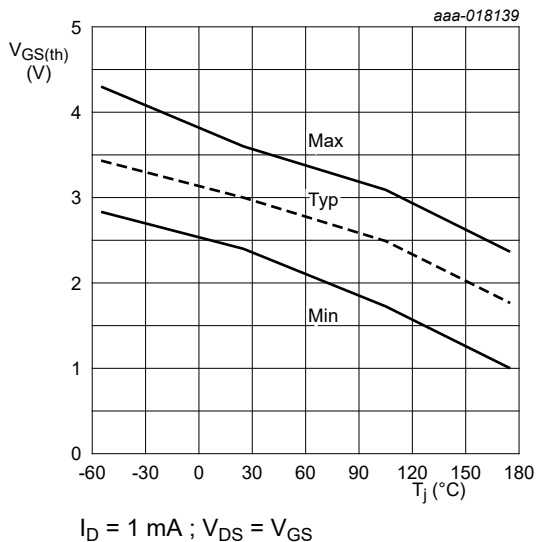


Fig. 10. Gate-source threshold voltage as a function of junction temperature

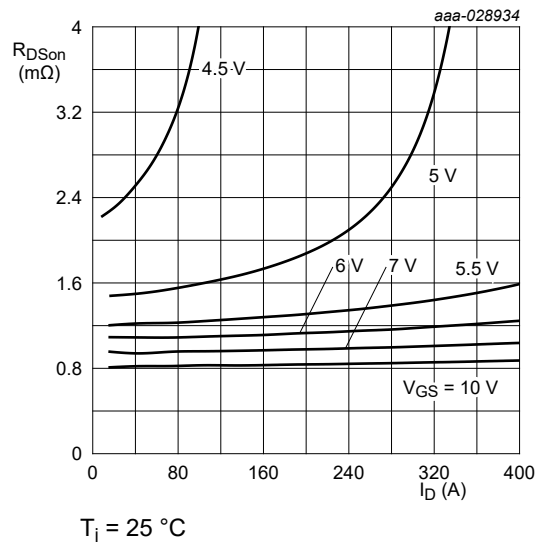


Fig. 11. Drain-source on-state resistance as a function of drain current; typical values

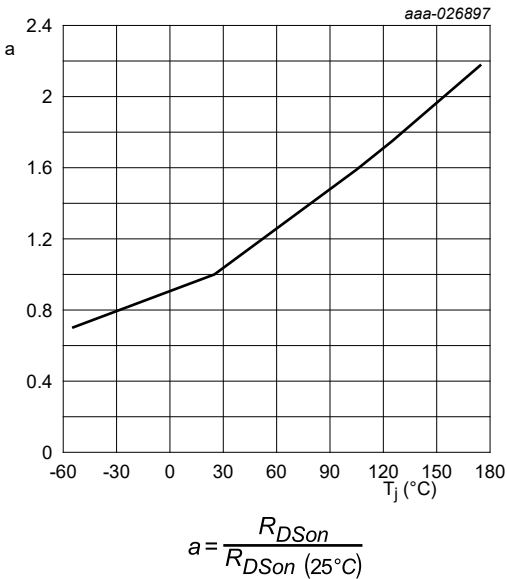


Fig. 12. Normalized drain-source on-state resistance factor as a function of junction temperature

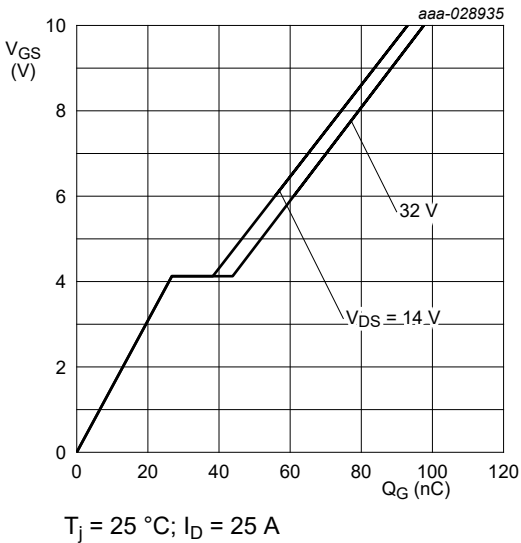


Fig. 13. Gate-source voltage as a function of gate charge; typical values

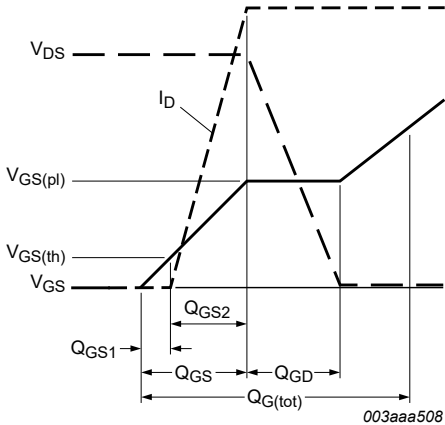


Fig. 14. Gate charge waveform definitions

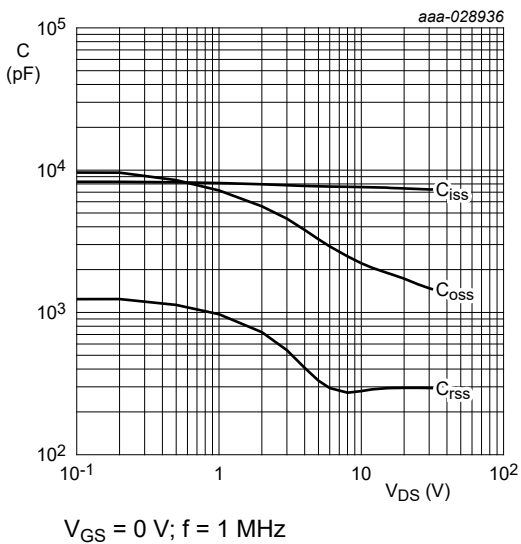
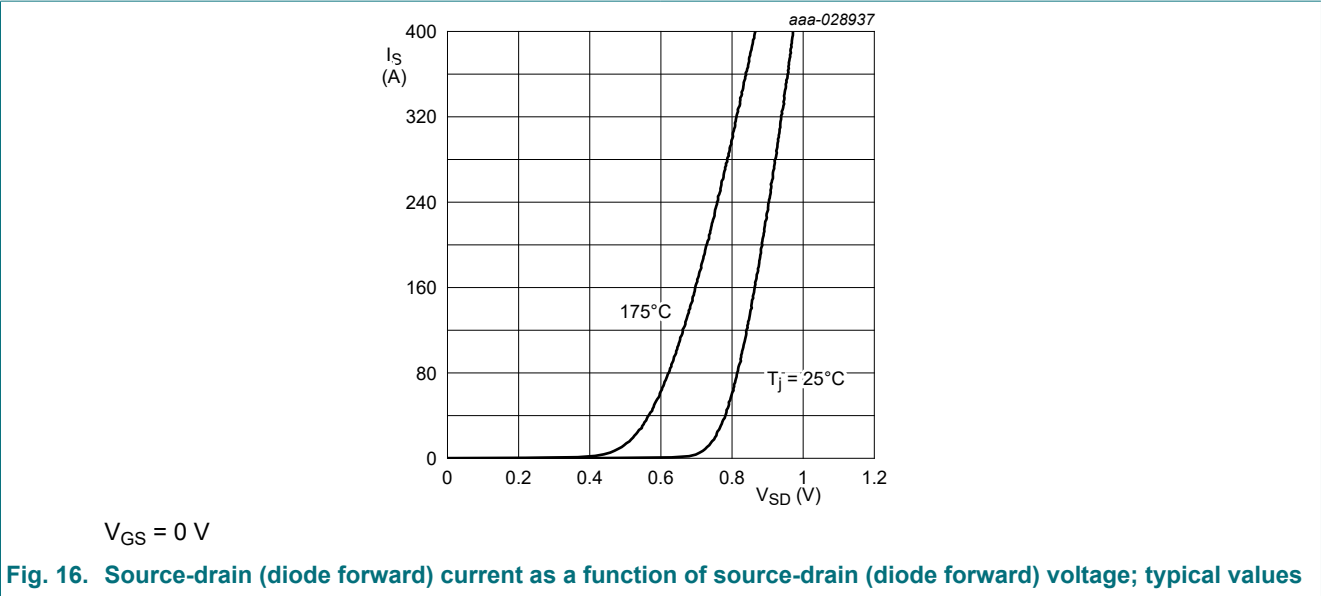


Fig. 15. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values



11. Package outline

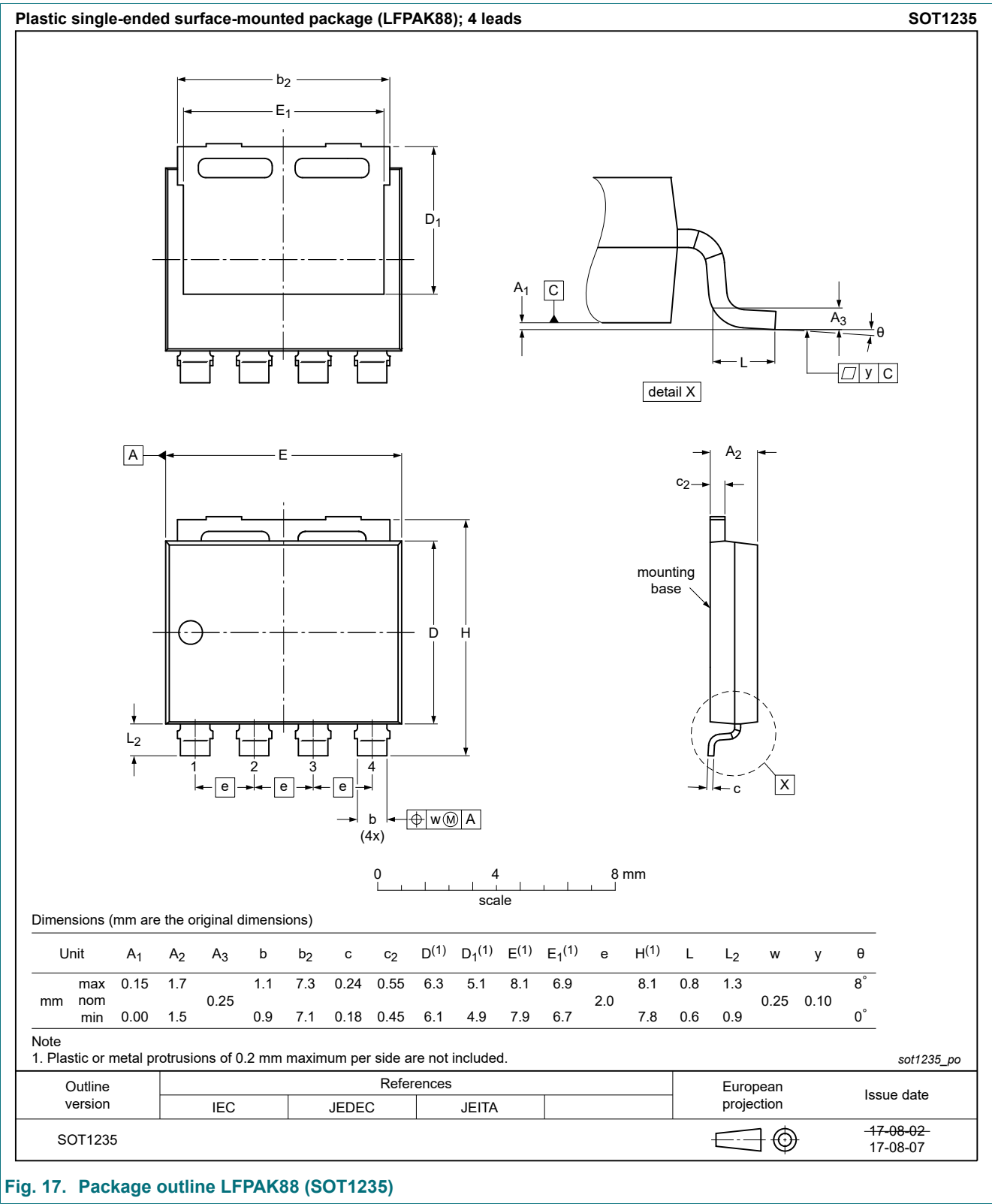


Fig. 17. Package outline LPAK88 (SOT1235)

12. Soldering

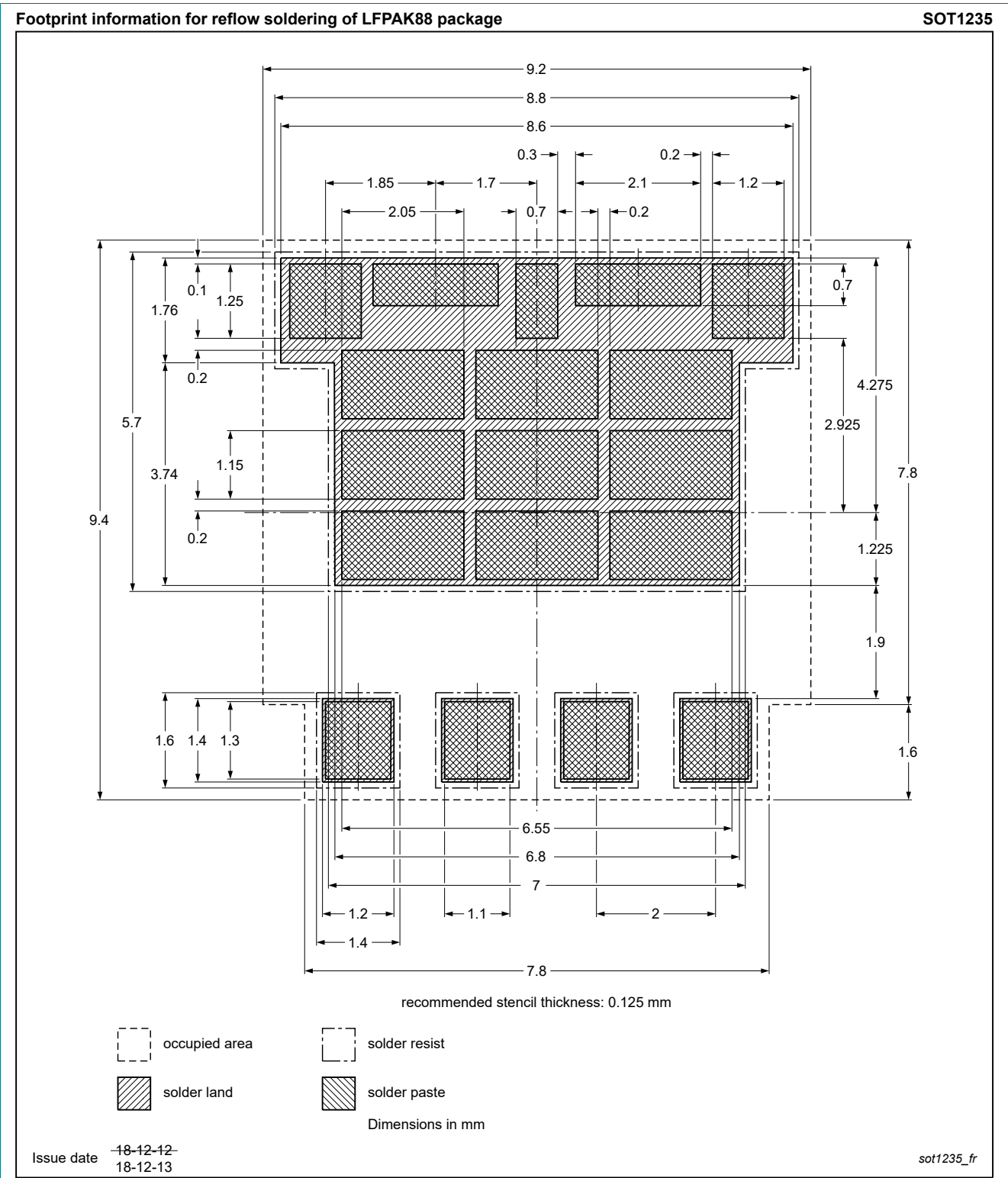


Fig. 18. Reflow soldering footprint for LPAK88 (SOT1235)

13. Legal information

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|--------------------------------|--------------------|---|
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Contents

1. General description..... 1

2. Features and benefits..... 1

3. Applications..... 1

4. Quick reference data..... 1

5. Pinning information.....2

6. Ordering information.....2

7. Marking.....2

8. Limiting values..... 2

9. Thermal characteristics..... 4

10. Characteristics..... 5

11. Package outline..... 10

12. Soldering..... 11

13. Legal information.....12

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Date of release: 26 April 2019

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«JONHON» (основан в 1970 г.)

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(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели,
кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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